

Single P-channel MOSFET

ELM13419CA-S

■ General description

ELM13419CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance. Internal ESD protection is included.

■ Features

- $V_{ds} = -20V$
- $I_d = -3.5A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 75m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 95m\Omega$ ($V_{gs} = -4.5V$)
- $R_{ds(on)} < 145m\Omega$ ($V_{gs} = -2.5V$)
- ESD Rating : 2000V HBM

■ Maximum absolute ratings

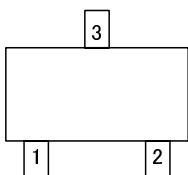
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-20	V	
Gate-source voltage	V_{gs}	± 12	V	
Continuous drain current	I_d	-3.5	A	1
$T_a = 70^\circ C$		-2.8		
Pulsed drain current	I_{dm}	-15	A	2
Power dissipation	P_d	1.4	W	1
$T_a = 70^\circ C$		0.9		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

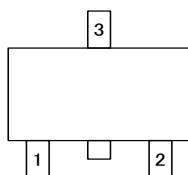
Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	65	90	°C/W	1
Maximum junction-to-ambient		85	125	°C/W	
Maximum junction-to-lead	$R_{\theta jl}$	43	60	°C/W	3

■ Pin configuration

SOT-23 (TOP VIEW)



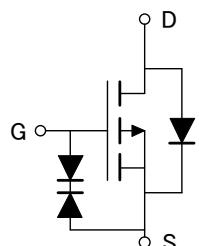
(Without extra bar)



(With extra bar)

Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

■ Circuit



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■ Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	$Id=-250\ \mu A, Vgs=0V$	-20			V
Zero gate voltage drain current	Idss	$Vds=-16V$ $Vgs=0V$			-0.5 -2.5	μA
			$T_j=55^\circ C$			
Gate-body leakage current	Igss	$Vds=0V, Vgs=\pm 10V$ $Vds=0V, Vgs=\pm 12V$			± 1 ± 10	μA
Gate threshold voltage	Vgs(th)	$Vds=Vgs, Id=-250\ \mu A$	-0.7	-0.9	-1.4	V
On state drain current	Id(on)	$Vgs=-4.5V, Vds=-5V$	-15			A
Static drain-source on-resistance	Rds(on)	$Vgs=-10V$ $Id=-3.5A$ $Vgs=-4.5V, Id=-3A$ $Vgs=-2.5V, Id=-1A$		59 83 76 111	75 105 95 145	$m\Omega$
			$T_j=125^\circ C$			
Forward transconductance	Gfs	$Vds=-5V, Id=-3.5A$		6.8		S
Diode forward voltage	Vsd	$Is=-1A, Vgs=0V$	-0.65	-0.81	-0.95	V
Max. body-diode continuous current	Is				-2.0	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	$Vgs=0V, Vds=-10V, f=1MHz$		512	620	pF
Output capacitance	Coss			77		pF
Reverse transfer capacitance	Crss			62		pF
Gate resistance	Rg	$Vgs=0V, Vds=0V, f=1MHz$		9.2	13.0	Ω
SWITCHING PARAMETERS						
Total gate charge	Qg	$Vgs=-4.5V, Vds=-10V$ $Id=-3.5A$		5.5	6.6	nC
Gate-source charge	Qgs			0.8		nC
Gate-drain charge	Qgd			1.9		nC
Turn-on delay time	td(on)	$Vgs=-10V, Vds=-10V$ $Rl=2.8\ \Omega, Rgen=3\ \Omega$		5.0		ns
Turn-on rise time	tr			6.7		ns
Turn-off delay time	td(off)			28.0		ns
Turn-off fall time	tf			13.5		ns
Body diode reverse recovery time	trr	$If=-3.5A, dl/dt=100A/\mu s$		9.8	12.0	ns
Body diode reverse recovery charge	Qrr	$If=-3.5A, dl/dt=100A/\mu s$		2.7		nC

NOTE :

1. The value of $R\theta_{ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R\theta_{ja}$ is the sum of the thermal impedance from junction to lead $R\theta_{jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

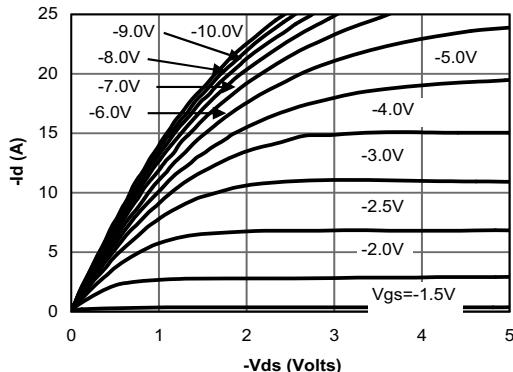


Fig 1: On-Region Characteristics

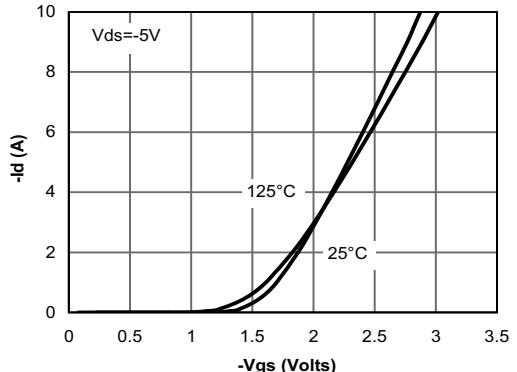


Figure 2: Transfer Characteristics

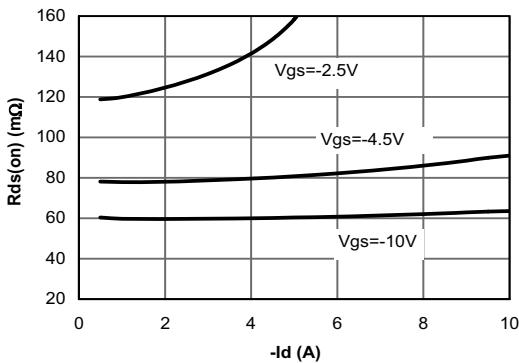


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

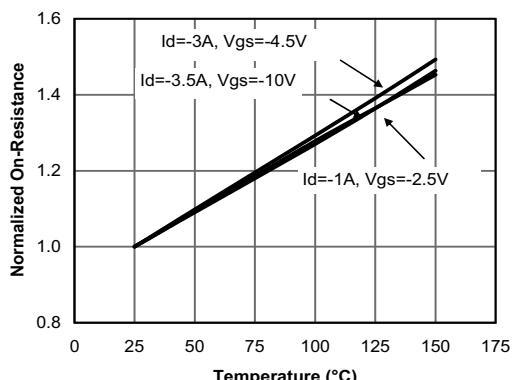


Figure 4: On-Resistance vs. Junction Temperature

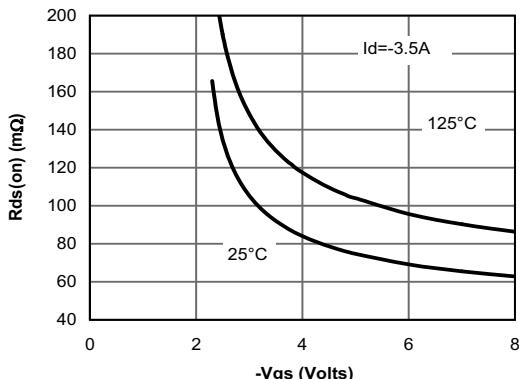


Figure 5: On-Resistance vs. Gate-Source Voltage

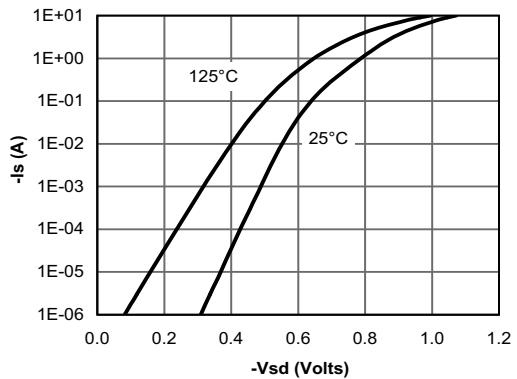


Figure 6: Body-Diode Characteristics

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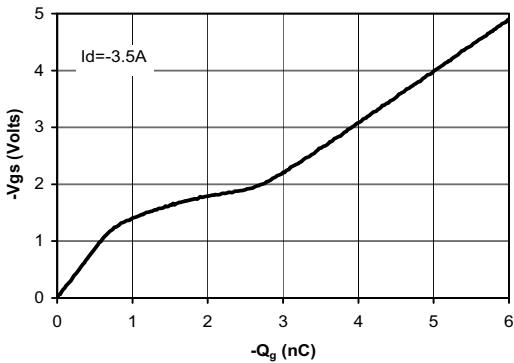


Figure 7: Gate-Charge Characteristics

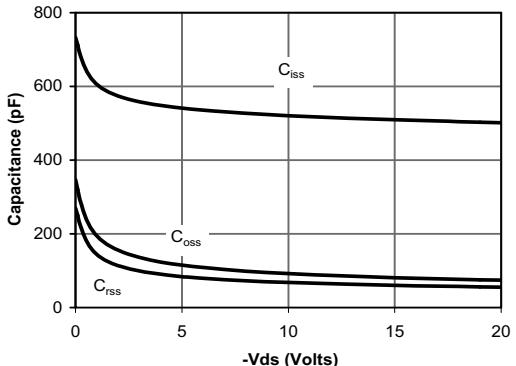


Figure 8: Capacitance Characteristics

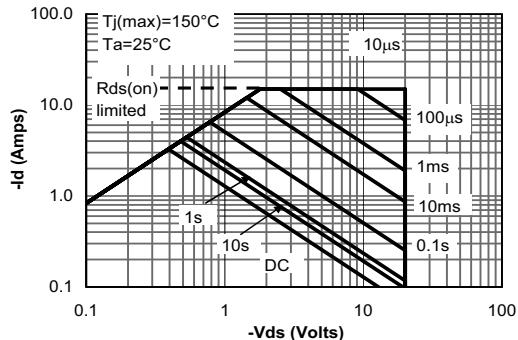


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

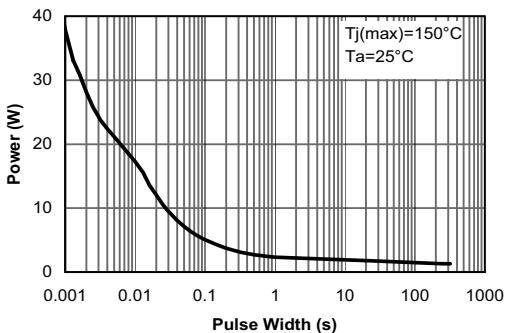


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

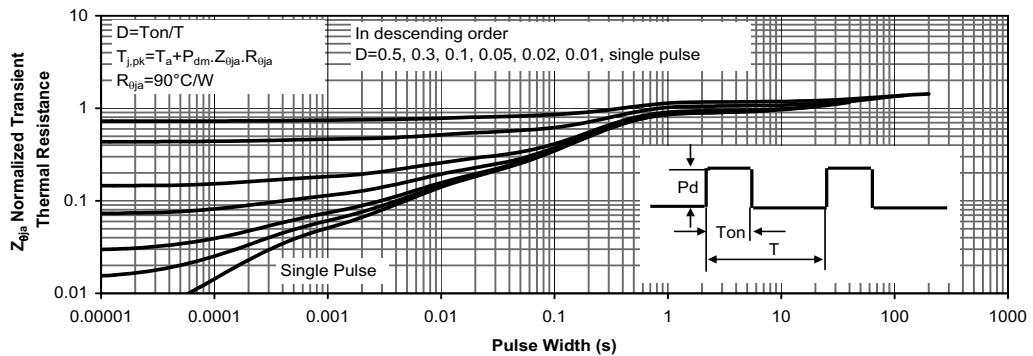


Figure 11: Normalized Maximum Transient Thermal Impedance